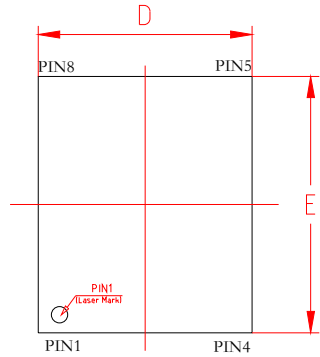


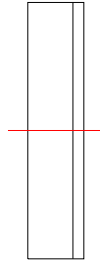
TOP VIEW

正视图



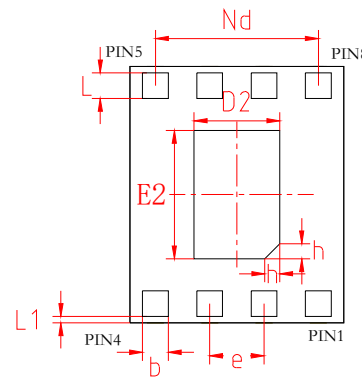
SIDE VIEW

侧视图



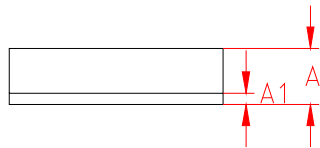
BOTTOM VIEW

背视图




SIDE VIEW

侧视图



机械尺寸/mm

字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	1.210	1.310	1.410
A1	0.230	0.260	0.290
b	0.550	0.600	0.650
D	4.900	5.000	5.100
Nd	3.810 BSC		
e	1.270 BSC		
E	5.900	6.000	6.100
D2	1.900	2.000	2.100
E2	2.900	3.000	3.100
L	0.550	0.600	0.650
h	0.300	0.350	0.400
L1	0.100	0.150	0.200

 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD				制图: Draw	NINGLIN 2024. 3. 1
HY-POD-LGA0010				制图核查: Drawing review	
PACKAGE OUTLINE DIMENSIONS LGA8L (5×6×1.31-P1.27)				审核: Checker	
页数 page	单位 unit	比例 scale	视图 view	核准: Approved	
	mm	1:1	